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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
09/967,044	09/28/2001	Douglas T. Grider	TI-31118	4815
23494 7	7590 12/04/2002			
TEXAS INSTRUMENTS INCORPORATED			EXAMINER	
P O BOX 6554 DALLAS, TX	K 655474, M/S 3999 S, TX 75265		MALDONADO, JULIO J	
			ART UNIT	PAPER NUMBER
		2823		

DATE MAILED: 12/04/2002

Please find below and/or attached an Office communication concerning this application or proceeding.

,	Application No.	Applicant(s)				
	09/967,044	GRIDER, DOUGLAS T.				
Office Action Summary	Examiner	Art Unit				
	Julio J. Maldonado	2823				
The MAILING DATE of this communication appears on the cover sheet with the correspondence address Period for Reply						
A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) FROM THE MAILING DATE OF THIS COMMUNICATION.  - Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.  - If the period for reply specified above is less than thirty (30) days, a reply within the statutory minimum of thirty (30) days will be considered timely.  - If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.  - Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133).  - Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).  Status						
1) Responsive to communication(s) filed on 04 C	October 2002 .					
2a) This action is <b>FINAL</b> . 2b)⊠ Thi	is action is non-final.					
3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is						
closed in accordance with the practice under <i>Ex parte Quayle</i> , 1935 C.D. 11, 453 O.G. 213. <b>Disposition of Claims</b>						
4) Claim(s) 1-10 is/are pending in the application.						
4a) Of the above claim(s) is/are withdrawn from consideration.						
5) Claim(s) is/are allowed.						
6)⊠ Claim(s) <u>1-10</u> is/are rejected.						
7) Claim(s) is/are objected to.						
8) Claim(s) are subject to restriction and/or	r election requirement.					
Application Papers						
9) The specification is objected to by the Examiner.  10) The drawing(s) filed on is/are: a) accepted or b) objected to by the Examiner.						
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).						
11) ☐ The proposed drawing correction filed on is: a) ☐ approved b) ☐ disapproved by the Examiner.						
If approved, corrected drawings are required in reply to this Office action.						
12) The oath or declaration is objected to by the Examiner.						
Priority under 35 U.S.C. §§ 119 and 120						
13) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).						
a) ☐ All b) ☐ Some * c) ☐ None of:						
1. Certified copies of the priority documents have been received.						
2. Certified copies of the priority documents have been received in Application No						
3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)). * See the attached detailed Office action for a list of the certified copies not received.						
14) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).						
a) ☐ The translation of the foreign language provisional application has been received. 15)☐ Acknowledgment is made of a claim for domestic priority under 35 U.S.C. §§ 120 and/or 121.						
Attachment(s)						
1) Notice of References Cited (PTO-892) 2) Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) Information Disclosure Statement(s) (PTO-1449) Paper No(s)	5) Notice of Informa	ry (PTO-413) Paper No(s) I Patent Application (PTO-152)				

U.S. Patent and Trademark Office PTO-326 (Rev. 04-01)

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### **DETAILED ACTION**

### Election/Restrictions

1. Applicant's election without traverse of claims 1-10 in Paper No. 4 is acknowledged.

## Claim Rejections - 35 USC § 103

- 2. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
  - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 3. Claims 1-3 are rejected under 35 U.S.C. 103(a) as being unpatentable over Tsunoda (U.S. 5,698,464) in view of Kraft et al. (U.S. 6,136,654).

Tsunoda (Figs.1-6) in a related method to form an oxynitride layer teaches the steps of providing a semiconductor substrate (1); forming an oxide layer (12) on the semiconductor substrate (1); incorporating nitrogen into the oxide layer (12) thereby converting the oxide layer (12) to an oxynitride layer (14); and annealing said oxynitride layer (14) in  $N_2$ O to form an oxynitride layer with a uniform nitrogen concentration profile, wherein said annealing comprises rapid thermal annealing at a temperature of  $700^{\circ}$ C –  $1,100^{\circ}$ C for 10 – 60 seconds (column 2, line 55 – column 4, line 10).

Tsunoda fails to teach incorporating nitrogen by exposing the oxide layer to a high-density nitrogen plasma. However, Kraft et al. (Figs.1-2) in a related method to form a gate oxynitride structure teach the steps of forming a gate oxide layer (14) and exposing the oxide layer to a high-density nitrogen plasma (column 3, line 58 – column

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5, line 60). Therefore, it would have been obvious to one of ordinary skill in the art at the of the invention was made to form the silicon oxynitride layer as taught by Kraft in the method of Tsunoda, since this would result in a dielectric layer substantially free of contaminants (e.g. hydrogen) (column 2, lines 44-45).

Still, Tsunoda in combination with Kraft et al. fail to teach applying the high density plasma at a power level of 700 – 900 watts. However, the selection of the claimed range is obvious because it is a matter of determining optimum process condition by routine experimentation with a limited number of species. In re Jones, 162 USPQ 224 (CCPA 1955)(the selection of optimum ranges within prior art general conditions is obvious) and In re Boesch, 205 USPQ 215 (CCPA 1980)(discovery of optimum value of result effective variable in a known process is obvious).

4. Claims 4 and 8 –10 are rejected under 35 U.S.C. 103(a) as being unpatentable over Tobin et al. (U.S. 5,972,804) in view of Tsunoda ('464).

Tobin et al. (Figs.13-18) in a related method to form a field effect transistor structure teach the steps of providing a semiconductor substrate (13); forming a gate dielectric layer (23) on the semiconductor substrate (13); forming a conductive layer (43) on said gate dielectric layer (23); forming sidewall structures (54) adjacent to said conductive layer (23); and forming source and drain regions (56) in the semiconductor substrate (13) adjacent to said sidewall (54) structures (column 12, line 36 – column 14, line 6).

Tobin et al. fail to teach wherein the gate dielectric layer has a uniform nitrogen concentration. However, Tsunoda (Figs.1-6) in a related method to form a dielectric

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layer teach providing a substrate (11); and forming a dielectric layer (12) over the substrate (11), wherein the gate dielectric layer (12) has a uniform nitrogen concentration (column 2, line 55 - column 4, line 10). Therefore, it would have been obvious to one of ordinary skill in the art at the time of the invention was made to form the oxide layer as taught by Tsunoda in the method of Tobin et al., since this would reduce the leakage of the formed gate oxide (column 1, lines 32 - 60). In reference to claims 8 – 10, Tobin et al. in combination with Tsunoda substantially teach all aspects of the invention but fail to show that said uniform nitrogen concentration is greater than 6 atomic percent; the gate dielectric layer having a thickness of less than 40 Angstroms thick; and said uniform nitrogen concentration describes a nitrogen concentration with less than 10% variation across the gate dielectric layer. However, the selection of the claimed ranges is obvious because it is a matter of determining optimum process condition by routine experimentation with a limited number of species. In re Jones, 162 USPQ 224 (CCPA 1955)(the selection of optimum ranges within prior art general conditions is obvious) and In re Boesch, 205 USPQ 215 (CCPA 1980)(discovery of optimum value of result effective variable in a known process is obvious).

5. Claims 5-7 are rejected under 35 U.S.C. 103(a) as being unpatentable over Tobin et al. ('804) in view of Tsunoda ('464) as applied to claims 4 above, and further in view of Kraft et al. ('654).

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Tobin et al. in combination with Tsunoda teach forming an oxide layer (12) on the semiconductor substrate (1); incorporating nitrogen into the oxide layer (12) thereby converting the oxide layer (12) to an oxynitride layer (14); and annealing said oxynitride layer (14) in  $N_2O$  to form an oxynitride layer with a uniform nitrogen concentration profile, wherein said annealing comprises rapid thermal annealing at a temperature of  $700^{\circ}C - 1.100^{\circ}C$  for 10 - 60 seconds (column 2, line 55 - column 4, line 10).

Tobin et al. in combination with Tsunoda fail to teach incorporating nitrogen by exposing the oxide layer to a high-density nitrogen plasma. However, Kraft et al. (Figs.1-2) in a related method to form a gate oxynitride structure teach the steps of forming a gate oxide layer (14) and exposing the oxide layer to a high-density nitrogen plasma (column 3, line 58 – column 5, line 60). Therefore, it would have been obvious to one of ordinary skill in the art at the of the invention was made to form the silicon oxynitride layer as taught by Kraft in the method of Tsunoda, since this would result in a dielectric layer substantially free of contaminants (e.g. hydrogen) (column 2, lines 44-45).

Still, Tobin in combination with Tsunoda and Kraft et al. fail to teach applying the high density plasma at a power level of 700 – 900 watts. However, the selection of the claimed range is obvious because it is a matter of determining optimum process condition by routine experimentation with a limited number of species. In re Jones, 162 USPQ 224 (CCPA 1955)(the selection of optimum ranges within prior art general conditions is obvious) and In re Boesch, 205 USPQ 215 (CCPA 1980)(discovery of optimum value of result effective variable in a known process is obvious).

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#### Conclusion

Papers related to this application may be submitted directly to Art Unit 2823 by facsimile transmission. Papers should be faxed to Art Unit 2823 via the Art Unit 2823 Fax Center located in Crystal Plaza 4, room 3C23. The faxing of such papers must conform to the notice published in the Official Gazette, 1096 OG 30 (15 November 1989). The Art Unit 2823 Fax Center number is (703) 305-3432. The Art Unit 2823 Fax Center is to be used only for papers related to Art Unit 2823 applications.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to **Julio J. Maldonado** at **(703)** 306-0098 and between the hours of 8:00 AM to 4:00 PM (Eastern Standard Time) Monday through Friday or by email via <u>julio.maldonado@uspto.gov</u>. If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Olik Chaudhuri, can be reached on (703) 306-2794.

Any inquiry of a general nature or relating to the status of this application should be directed to the **Group 2800 Receptionist** at **(703) 308-0956**.

Julio J. Maldonado

Patent Examiner Art Unit 2823 703-306-0098

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Olik Chardhuri

Supervisory Patent Examiner Technology Center 2800 Page 6